## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

LEE, Yong-Hun 10/564,417

Applicant: Serial No.:

Conf. No.:	9507
Filed:	January 11, 2006
Title:	ACRYLIC COPOLYMER COMPOSITION, METHOD FOR
11111	PREPARING ACRYLIC COPOLYMER, AND VINYL CHLORIDE
	RESIN COMPOSITION CONTAINING THE ACRYLIC COPOLMER
Eveninon	
Examiner:	RABAGO, Roberto
Art Unit:	1796
Docket No:	NEK-0008
Commissione	er for Patents
P.O. Box 145	0
	A 22313-1450
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	DECLARATION UNDER 37 CFR § 1.132
	DECLARATION UNDERGY CIRCY 1.102
	Now comes Vonghum Lee who deposes and states that:
	Now comes vong // Who deposes and states that.
1.	I am an inventor in the above-identified application;
2.	I am a graduate of <u>Pusan National University</u> and received my <u>M.S. (in dremistry)</u> degree in the year <u>IPPY</u> ;
	11 = 62 1 2 1 2 1
	M.S. (M Chemistry) degree in the year / fry;
3.	I have been employed by LG Chem, LTD since, and I
	have been conducting research in the field of Polymer Chemistry for
	/ years;
4.	The experiments described in the above-identified application were conducted
••	The arterior departed and the month of the above abbreauton attended
	hv

me or under my direct supervision.

- 5. The application, as filed, contained a translational error throughout the specification that listed aryl methacrylate instead of correctly listing allyl methacrylate.
- 6. The examples given and the experiments described in the specification utilized the species allyl methacrylate and not aryl methacrylate which is a generic term not a species.
- 7. The undersigned petitioner declares further that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the Unites States Code and that such willful false statements may jeopardize the validity of this application or any patent issuing thereon.

8. Further deponent saith not.

Signature

2008.12.15

Date